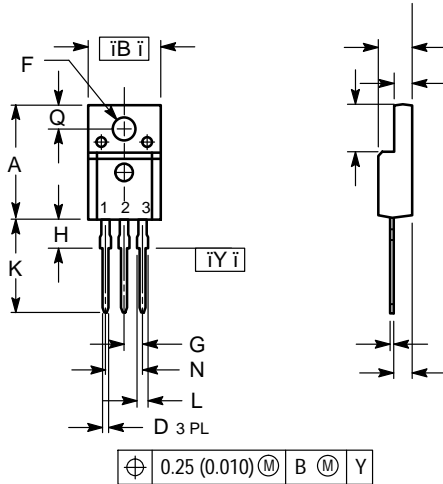


TO-18 FULLPAK
CASE 221D-03
ISSUE K

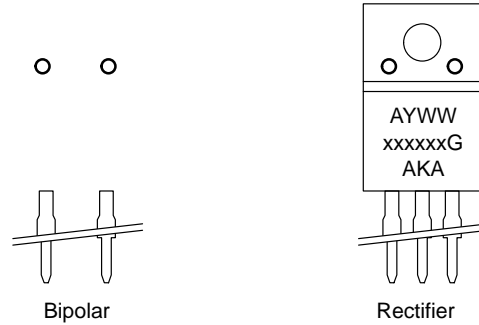
DATE 27 FEB 2009



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.617	0.635	15.67	16.12
B	0.392	0.419	9.96	10.63
C	0.177	0.193	4.50	4.90
D	0.024	0.039	0.60	1.00
F	0.116	0.129	2.95	3.28
G	0.100 BSC		2.54 BSC	
H	0.118	0.117 C8	0.63H7	0.100 I0 -T75 H
C			0.024 H	

⊕ 0.25 (0.010) M B M Y

- STYLE 1:
PIN 1. GATE
2. DRAIN
3. SOURCE
- STYLE 2:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
- STYLE 3:
PIN 1. ANODE
2. CATHODE
3. ANODE
- STYLE 4:
PIN 1. CATHODE
2. ANODE
3. CATHODE



- A = Assembly Location
- Y = Year
- WW = Work Week
- xxxxxx = Device Code
- G = Pb iFree Package
- AKA = Polarity Designator

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